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## 8-PIN DIP, 250 V BREAK DOWN VOLTAGE TRANSFER TYPE <br> -NEPOC Series-2-ch Optical Coupled MOS FET

## DESCRIPTION

The PS7122A-1C and PS7122AL-1C are transfer type solid state relays containing normally open (N.O.) contact and normally close (N.C.) contact on the output side.

They are suitable for analog signal control because of their low offset and high linearity.
The PS7122AL-1C has a surface mount type lead.

## FEATURES

- 2 channel type (1 a + 1 b output)
- Low LED operating current ( $\mathrm{IF}=2 \mathrm{~mA}$ )
- Designed for AC/DC switching line changer
- Small package (8-pin DIP)
- Low offset voltage
- Ordering number of taping product: PS7122AL-1C-E3, E4: $1000 \mathrm{pcs} /$ reel
- Pb-Free product
- Safety standards
- UL approved: File No. E72422
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391


## APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

[^0] that this is the latest version.

PACKAGE DIMENSIONS (in millimeters)


## PS7122AL-1C




ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ${ }^{* 1}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PS7122A-1C | PS7122A-1C-A | Pb -Free | Magazine case 50 pcs | Standard products (UL, BSI, CSA approved) | PS7122A-1C |
| PS7122AL-1C | PS7122AL-1C-A |  |  |  |  |
| PS7122AL-1C-E3 | PS7122AL-1C-E3-A |  | Embossed Tape $1000 \mathrm{pcs} / \mathrm{reel}$ |  |  |
| PS7122AL-1C-E4 | PS7122AL-1C-E4-A |  |  |  |  |

*1 For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter |  | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Current (DC) | IF | 50 | mA/ch |
|  | Reverse Voltage | $V_{\text {R }}$ | 5.0 | V |
|  | Power Dissipation | PD | 50 | $\mathrm{mW} / \mathrm{ch}$ |
|  | Peak Forward Current ${ }^{* 1}$ | Ifp | 1 | A/ch |
| MOS FET | Break Down Voltage | V ${ }_{\text {L }}$ | 250 | V |
|  | Continuous Load Current | IL | 200 | mA/ch |
|  | Pulse Load Current ${ }^{* 2}$ <br> (AC/DC Connection) | ILP | 400 | mA/ch |
|  | Power Dissipation | Pd | 375 | mW/ch |
| Isolation Voltage ${ }^{* 3}$ |  | BV | 1500 | Vr.m.s. |
| Total Power Dissipation |  | PT | 850 | mW |
| Operating Ambient Temperature |  | TA | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature |  | $\mathrm{T}_{\text {stg }}$ | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |

*1 PW = $100 \mu \mathrm{~s}$, Duty Cycle $=1 \%$
*2 PW = 100 ms , 1 shot
*3 AC voltage for 1 minute at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{RH}=60 \%$ between input and output Pins 1-4 shorted together, 5-8 shorted together.

RECOMMENDED OPERATING CONDITIONS ( $\mathrm{TA}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ )

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| LED Operating Current | $\mathrm{I}_{\mathrm{F}}$ | 2 | 10 | 20 | mA |
| LED Off Voltage | $\mathrm{V}_{\mathrm{F}}$ | 0 |  | 0.5 | V |

ELECTRICAL CHARACTERISTICS ( $\mathrm{TA}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

| Parameter |  | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Diode | Forward Voltage | $V_{F}$ | $\mathrm{IF}=10 \mathrm{~mA}$ |  | 1.2 | 1.4 | V |
|  | Reverse Current | IR | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ |  |  | 5.0 | $\mu \mathrm{A}$ |
| MOS FET | Off-state Leakage Current | ILoff | N.O.: $\mathrm{IF}_{F}=0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{D}}=250 \mathrm{~V}$ |  | 0.03 | 1.0 | $\mu \mathrm{A}$ |
|  |  |  | N.C.: $\mathrm{IF}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{D}}=250 \mathrm{~V}$ |  |  |  |  |
|  | Output Capacitance | Cout | N.O.: $\mathrm{V}_{\mathrm{D}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 120 |  | $\mathrm{pF} / \mathrm{ch}$ |
|  |  |  | N.C.: $\mathrm{If}_{\text {f }}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{D}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 340 |  |  |
| Coupled | LED On-state Current | Ifon | N.O.: IL $=200 \mathrm{~mA}$ |  |  | 2.0 | mA |
|  | LED Off-state Current | IFoff | N.C.: $\mathrm{LL}=200 \mathrm{~mA}$ |  |  | 2.0 | mA |
|  | On-state Resistance | Ron1 | N.O.: $\mathrm{IF}_{F}=10 \mathrm{~mA}, \mathrm{IL}=10 \mathrm{~mA}$ |  | 4.5 | 8.0 | $\Omega$ |
|  |  |  | N.C.: $\mathrm{If}_{\mathrm{F}}=0 \mathrm{~mA}, \mathrm{IL}=10 \mathrm{~mA}$ |  |  |  |  |
|  |  | Ron2 | $\begin{aligned} & \text { N.O.: } \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{I}=200 \mathrm{~mA}, \mathrm{t} \leq 10 \\ & \mathrm{~ms} \end{aligned}$ |  |  |  |  |
|  |  |  | N.C.: $\mathrm{IF}^{\text {a }} 00 \mathrm{~mA}, \mathrm{lL}=200 \mathrm{~mA}, \mathrm{t} \leq 10 \mathrm{~ms}$ |  |  |  |  |
|  | Turn-on Time ${ }^{* 1,2}$ | ton (N.O.) | $\begin{aligned} & \mathrm{IF}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{O}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=500 \Omega, \\ & \mathrm{PW} \geq 10 \mathrm{~ms} \end{aligned}$ |  | 0.5 | 1.5 | ms |
|  |  | ton (N.C.) |  |  | 0.04 | 0.2 |  |
|  | Turn-off Time ${ }^{* 1,2}$ | $\mathrm{tofff}^{(N . O .)}$ |  |  | 0.04 | 0.2 |  |
|  |  | $\mathrm{t}_{\text {off (N.C.) }}$ |  |  | 0.5 | 1.5 |  |
|  | Isolation Resistance | Ri-o | V I-O $=1.0 \mathrm{kV}$ dc | $10^{9}$ |  |  | $\Omega$ |
|  | Isolation Capacitance | Cl-O | $\mathrm{V}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 1.1 |  | pF/ch |

*1 Test Circuit for Switching Time

N.O. (between pin 5 and 6)

N.C. (between pin 7 and 8)

*2 The turn-on time and turn-off time are specified as input-pulse width $\geq 10 \mathrm{~ms}$.
Be aware that when the device operates with an input-pulse width less than 10 ms , the turn-on time and turn-off time will increase.

TYPICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, unless otherwise specified)


Remark The graphs indicate nominal characteristics.

TURN-ON TIME vs. FORWARD CURRENT


NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE


NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE


Remark The graphs indicate nominal characteristics.

ON-STATE RESISTANCE (N.O.) DISTRIBUTION


TURN-ON TIME (N.O.) DISTRIBUTION


Turn-on Time ton (ms)

TURN-ON TIME (N.C.) DISTRIBUTION


ON-STATE RESISTANCE (N.C.) DISTRIBUTION


TURN-OFF TIME (N.O.) DISTRIBUTION


TURN-OFF TIME (N.C.) DISTRIBUTION


Remark The graphs indicate nominal characteristics.

## TAPING SPECIFICATIONS (in millimeters)

Outline and Dimensions (Tape)


Tape Direction


Outline and Dimensions (Reel)


Packing: 1000 pcs/reel


## RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than $220^{\circ} \mathrm{C}$
- Time to preheat temperature from 120 to $180^{\circ} \mathrm{C}$
- Number of reflows
- Flux
$260^{\circ} \mathrm{C}$ or below (package surface temperature)
10 seconds or less
60 seconds or less
$120 \pm 30$ s
Three
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)

Recommended Temperature Profile of Infrared Reflow

(2) Wave soldering

- Temperature
- Time
- Preheating conditions
- Number of times
- Flux
$260^{\circ} \mathrm{C}$ or below (molten solder temperature)
10 seconds or less
$120^{\circ} \mathrm{C}$ or below (package surface temperature)
One
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)
(3) Soldering by soldering iron
- Peak temperature (lead part temperature) $350^{\circ} \mathrm{C}$ or below
- Time (each pins) 3 seconds or less
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of $0.2 \mathrm{Wt} \%$ is recommended.)
(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
(b) Please be sure that the temperature of the package would not be heated over $100^{\circ} \mathrm{C}$.
(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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| :---: | :---: | :---: |

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